



Product Change Notification

Change Notification #: **115983 - 01**
Change Title: **Select Intel® SSD 545s Series,
Intel® SSD E 5100s Series,
Intel® SSD Pro 5450s,
Intel® SSD DC S3110 Series,
PCN 115983-01, Label,
Label Update,
Reason for Revision: Adding additional
SKU/MM#**
Date of Publication: **January 18, 2018**

Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	December 26, 2017
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Reason for Revision: Adding additional SKU/MM#

Description of Change to the Customer:

The Intel® SSD 545s Series, Intel® SSD E 5100s Series, Intel® SSD Pro 5450s Series and Intel® SSD DC S3110 Series SKUs listed in the Products Affected Table below will have the following label changes:

- Added Morocco and Ukraine Logos

Opal



Non
Opal



Opal



Non
Opal



Customer Impact of Change and Recommended Action:

The change in labeling only affects the label. There is no form, fit, function or visible change to the products listed in the Products Affected/Intel Order Codes table.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD 545s Series (256GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Retail Box Single Pack	SSDSCKKW256G8X1	958687
Intel® SSD 545s Series (512GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Retail Box Single Pack	SSDSCKKW512G8X1	958688
Intel® SSD 545s Series (256GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSCKKW256G8	958690
Intel® SSD Pro 5450s Series (256GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Retail Box Single Pack	SSDSCKKF256G8X1	958693
Intel® SSD Pro 5450s Series (512GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Retail Box Single Pack	SSDSCKKF512G8X1	958694
Intel® SSD 545s Series (128GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Retail Box Single Pack	SSDSCKKW128G8X1	959549
Intel® SSD 545s Series (128GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic 50 Pack	SSDSCKKW128G8	959551
Intel® SSD E 5100s Series (128GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Embedded Generic 50 Pack	SSDSCKKR128G8XC	960108
Intel® SSD E 5100s Series (256GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Embedded Generic 50 Pack	SSDSCKKR256G8XC	960109
Intel® SSD E 5100s Series (128GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Embedded Retail Single Pack	SSDSCKKR128G8X1	960796
Intel® SSD DC S3110 Series (256GB, M.2 80mm SATA 6Gb/s, 3D2, TLC) Generic Single Pack	SSDSCKKI256G801	963856

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
December 11, 2017	00	Originally Published PCN
January 18, 2018	01	Adding additional SKU/MM#



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115983 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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